



Thematic Network on Silicon on Insulator Technology, Devices and Circuits.  
[IST-1-506653-CA]

## EUROSIO "Who is Who" Guide

### *Name of the organisation*

<i>Organization Legal name:</i>	<b>TRACIT TECHNOLOGIES SA,</b>
<i>Organization short name:</i>	
<i>Internet homepage:</i>	<b>www.tracit-tech.com</b>

### *Contact person*

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### **Other Senior Researchers:** (up to 10 names, please include e-mail address)

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### **Experience and expertise fields:** (50 words)

Tracit Technologies is a spin-off from the CEA-LETI, specialized in thin film transfer by molecular adhesion and mechanical and/or chemical thinning.

TRACIT Technologies is specialized in BSOI wafers, customized BSOI wafers and D-BSOI™ wafers, and in the field of transfer of thin circuits onto different supports .

### **Facilities and Equipment:**

Clean-rooms with all the equipments to process BSOI wafers, to perform Direct Wafer Bonding (cleaning – annealing), chemical mechanical polishing, mechanical & chemical thinning.

### **Three last international research projects:**

- PICMOS (European Project 6<sup>th</sup> PCRD)